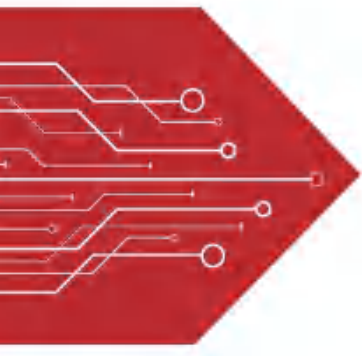


# MSKSEMI

SEMICONDUCTOR



ESD



TVS



TSS



MOV



GDT



PLED

Product data sheet

## FEATURES

- Low forward voltage
- High current capability
- High forward surge capability
- Low power losses, High efficiency
- Guarding for over voltage protection

## APPLICATIONS

Low VF Schottky barrier rectifier are designed for high frequency, miniature switched mode power supplies such as adapters ,lighting and on-board DC/DC conerters

### Primary Characteristic

$I_o$	2*10A
$V_{RRM}$	60V
$I_{FSM}$	300A
$V_F$	0.63V
$T_{Jmax}$	150°C
Assembly code	AJ

## MECHANICAL DATA

- **Case:** Molded plastic
- **Polarity:** As marked
- **Mounting Position:** Any
- **Molded Plastic:** UL Flammability Classification Rating 94V-0
- Lead free in compliance with EU RoHS 2011/65/EU directive
- Solder bath temperature 275°C maximum, 10s per JESD 22-B106

### Maximum Ratings (Per Leg) at Ta=25°C unless otherwise specified

Characteristics	Symbol	Value	Unit
Maximum Repetitive Peak Reverse Voltage	$V_{RRM}$	60	V
Working Peak Reverse Voltage	$V_{RWM}$	60	V
Maximum DC Blocking Voltage	$V_{DC}$	60	V
Maximum Average Forward Rectified Current	$I_o$	Per Leg	10
		Total	20
Peak Forward Surge Current, 8.3 ms Single Half Sine-wave	$I_{FSM}$	300	A
Operating Temperature Range	$T_J$	150	°C
Storage Temperature Range	$T_{STG}$	-40 to +150	°C
Typical Thermal Resistance (Note 1) TO-220AB, TO-263, TO-252 TO-220F	$R_{\theta JC}$	2 4	°C/W

Note1: Thermal resistance from Junction to case per leg mounted on heatsink.

### Electrical Characteristics (Per Leg) unless otherwise specified

Characteristics		Symbol	Value		Unit
Forward Voltage Drop (Note 2)		$V_F$	Typ.	Max.	V
at $I_F=3A$	TA=25°C		0.51	-	
	TA=125°C		0.45	-	
at $I_F=5A$	TA=25°C		0.59	-	
	TA=125°C		0.53	-	
at $I_F=10A$	TA=25°C		0.72	0.78	
	TA=125°C		0.63	-	
Maximum Reverse Current at $V_R=60V$	TA=25°C		$I_R$	3	
	TA=125°C		2	-	mA

Note2: Pulse test: 300 µs pulse width, 1 % duty cycle

## SCHOTTKY BARRIER RECTIFIER



TO-220AB/CT



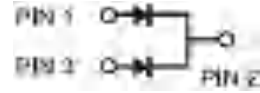
TO-220F/FCT



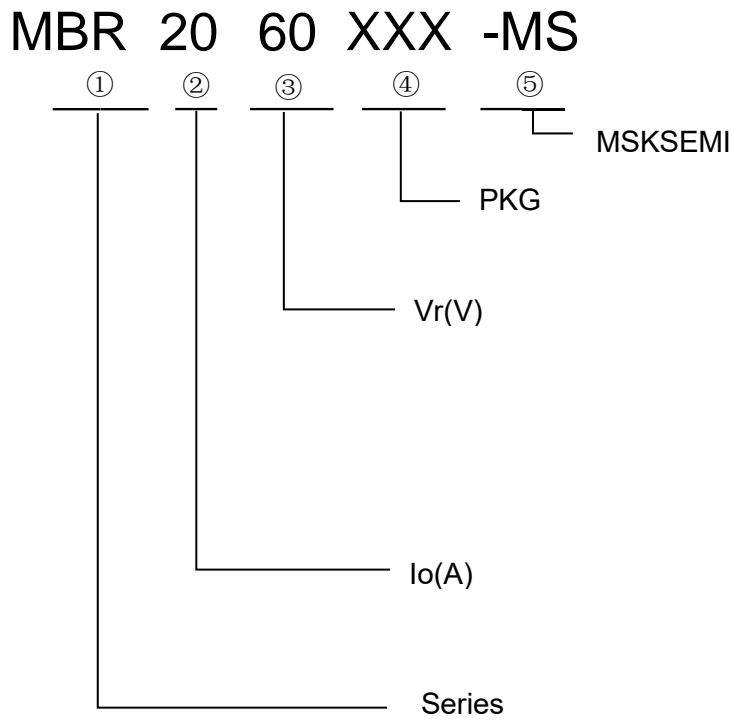
TO-263/DC



TO-252/CS



### P/N Information



①	②	③	④	⑤
系列	平均整流电流	直流反向耐压	封装	MSKSEMI

**RATINGS AND CHARACTERISTIC CURVES**

FIG.1 MAXIMUM FORWARD CURRENT DERATING CURVE

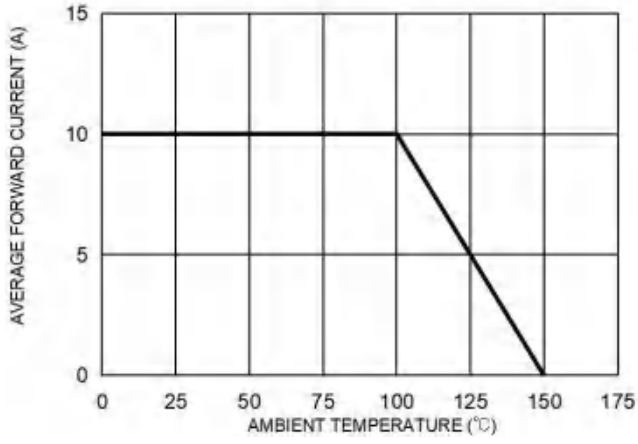


FIG. 2 MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT PER LEG

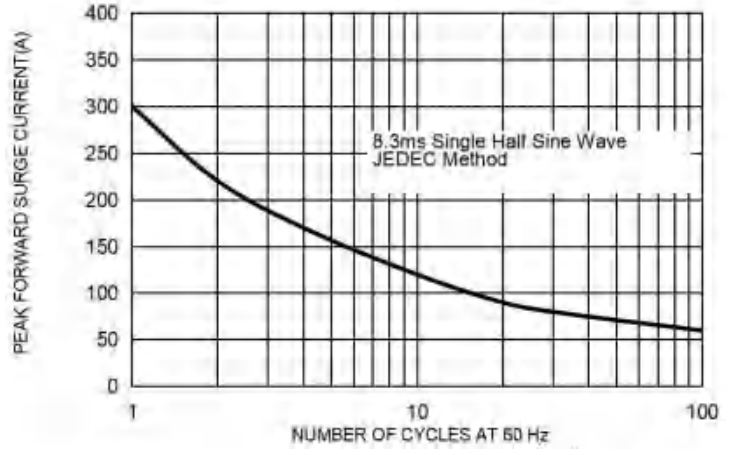


FIG. 3 TYPICAL FORWARD CHARACTERISTICS PER LEG

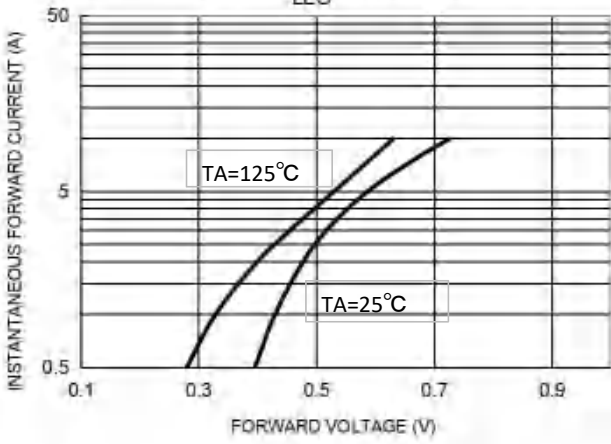
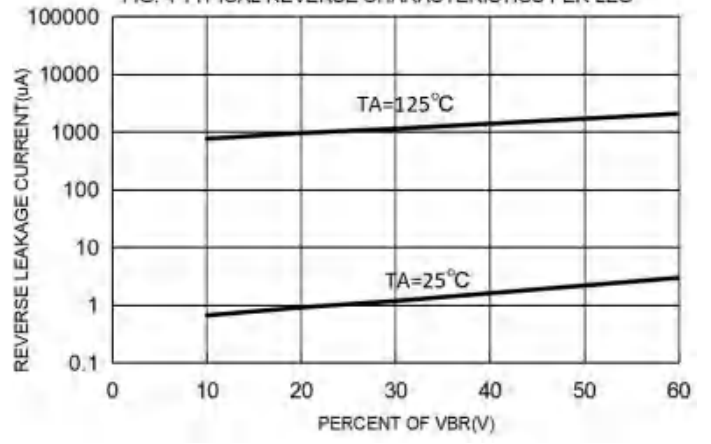
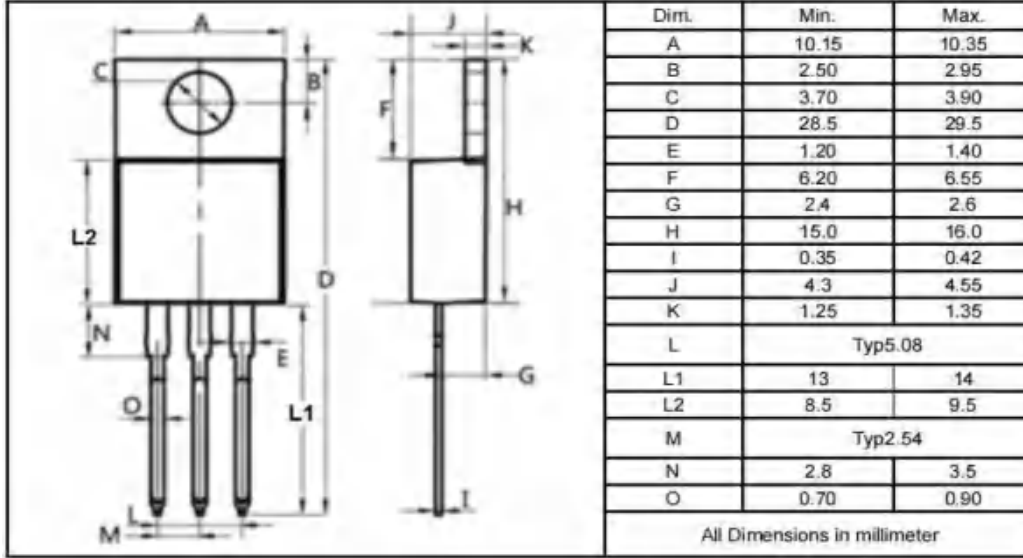


FIG. 4 TYPICAL REVERSE CHARACTERISTICS PER LEG



Package Outline Dimensions millimeters

TO-220AB

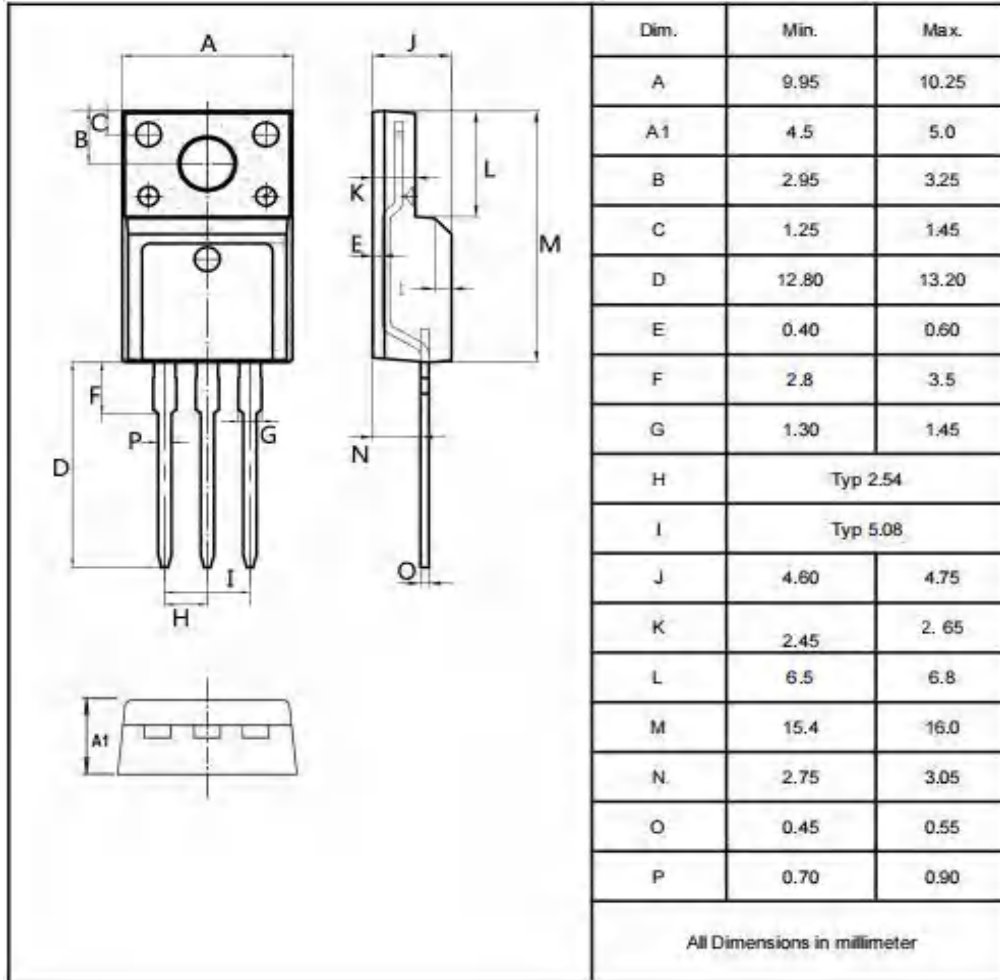


**REEL SPECIFICATION**

P/N	PKG	QTY
MBR2060CT-MS	TO-220AB	50pcs/tube 1000pcs/box

Package Outline Dimensions millimeters

TO-220F

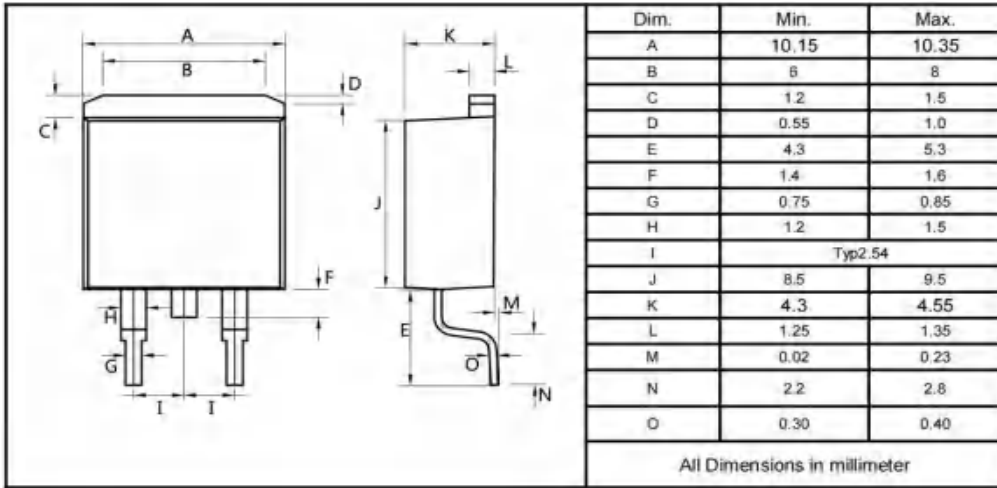


**REEL SPECIFICATION**

P/N	PKG	QTY
MBR2060FCT-MS	TO-220F	50pcs/tube 1000pcs/box

Package Outline Dimensions millimeters

TO-263



**REEL SPECIFICATION**

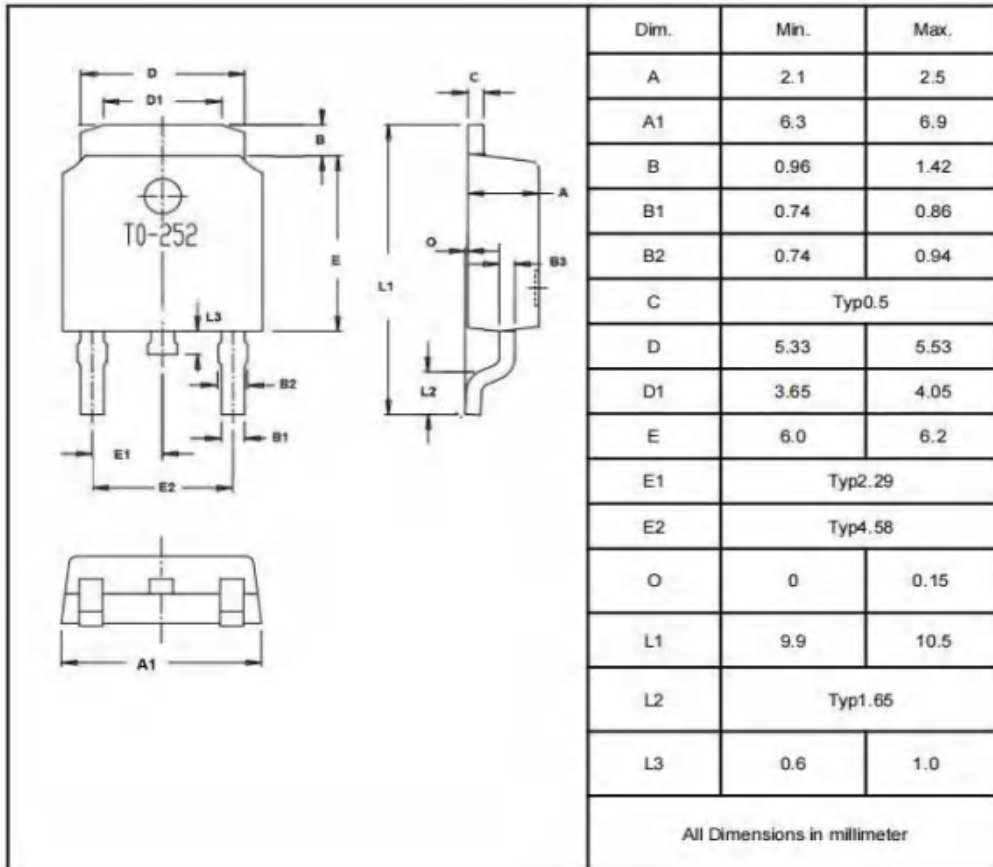
P/N	PKG	QTY
MBR2060DC-MS	TO-263	50pcs/tube 1000pcs/box

**REEL SPECIFICATION**

P/N	PKG	QTY
MBR2060DC-R-MS	TO-263	800pcs

Package Outline Dimensions millimeters

TO-252



**REEL SPECIFICATION**

P/N	PKG	QTY
MBR2060CS-MS	TO-252	2500



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